

Customer Information Notification

202203010I: Country Of Origin Label Change

Note: This notice is NXP Company Proprietary.				
Issue Date: Apr 15, 2022 Effective date: Apr 16, 2022 Change Category				
Wafer Fab Process	Assembly Process	☐ Product Marking	Test Process	Design
Wafer Fab Materials	Assembly Materials	Mechanical Specification	Test Equipment	□ Errata
Wafer Fab Location	Assembly Location	✓ Packing/Shipping/Labeling	Test Location	Electrical spec./Test coverage
l_ Firmware	Other			
PCN Overview				
Description				
NXP Semiconductors announces a change to the Country Of Origin listed on the Product Label for the Republic of Korea. Beginning the week of May 23, 2022, the NXP Product Label will list the Country Of Origin as SOUTH KOREA.				

Identification of Affected Products

Product identification does not change

Anticipated Impact on Form, Fit, Function, Reliability or Quality

To standardize all product packaging label from the Republic of Korea with one Country Of Origin

No Impact on form, fit, function, reliability or quality

Data Sheet Revision

No impact to existing datasheet

Disposition of Old Products

Existing inventory will be shipped until depleted

This is only a change to the Country Of Origin on the Product Label.

Additional information

Additional documents: view online

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

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Position Label Manager

e-mail

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At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards. Customer Focus, Passion to Win.

NXP Quality Management Team.

About NXP Semiconductors

NXP Semiconductors N.V. (NASDAQ: NXPI) provides High Performance Mixed Signal and Standard Product solutions that leverage its leading RF, Analog, Power Management, Interface, Security and Digital Processing expertise. These innovations are used in a wide range of automotive, identification, wireless infrastructure, lighting, industrial, mobile, consumer and computing applications.

NXP Semiconductors

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